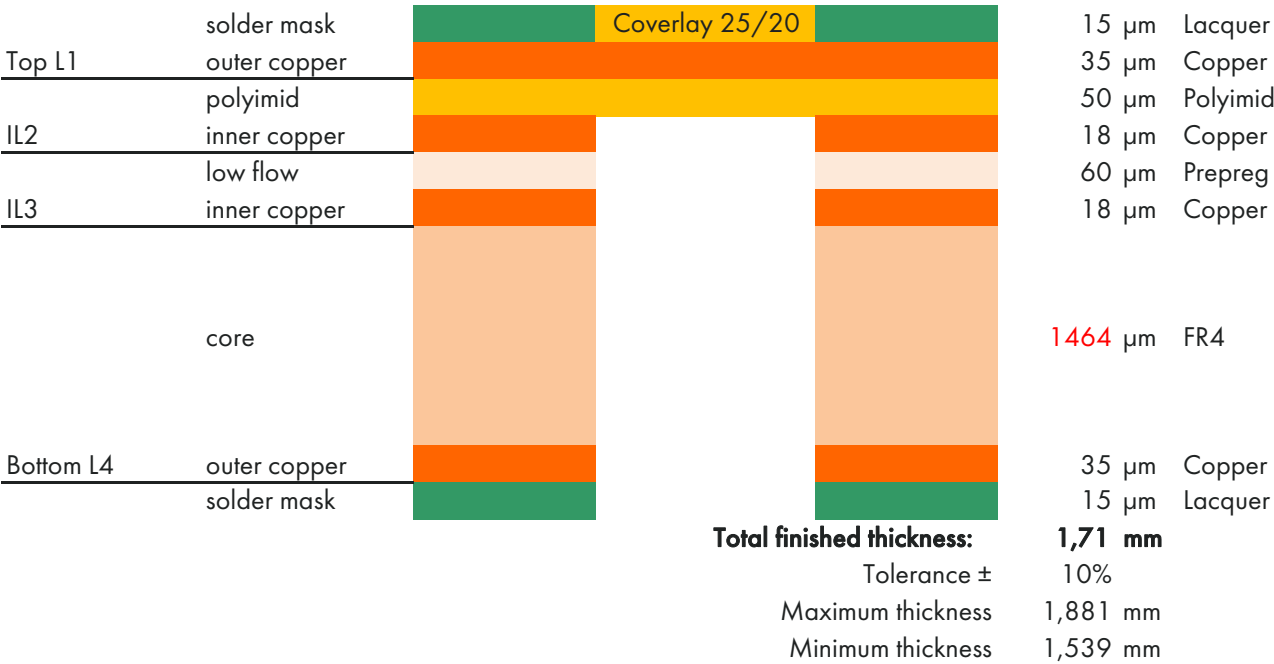
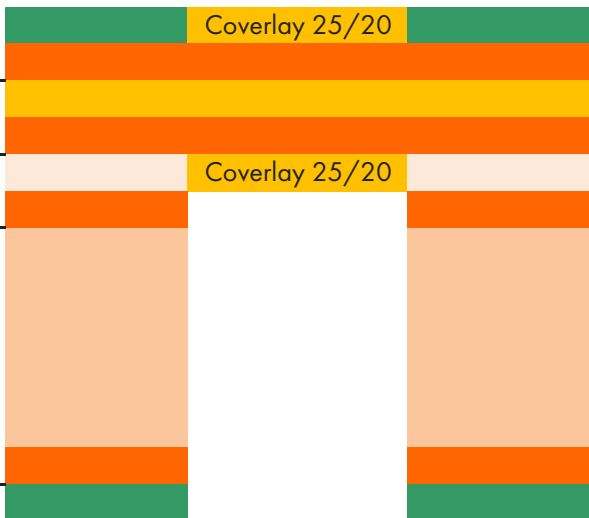
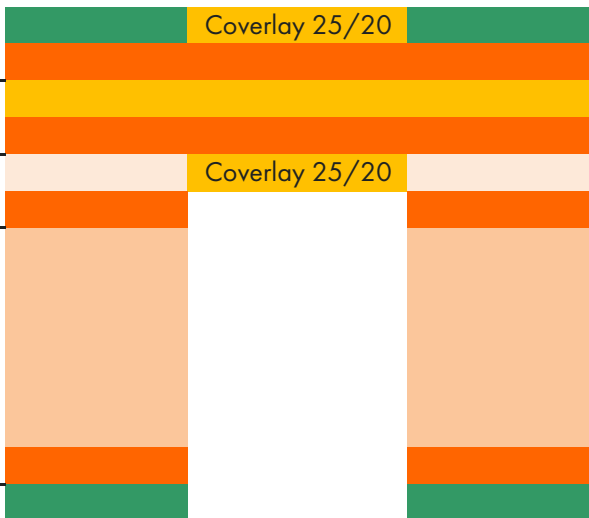
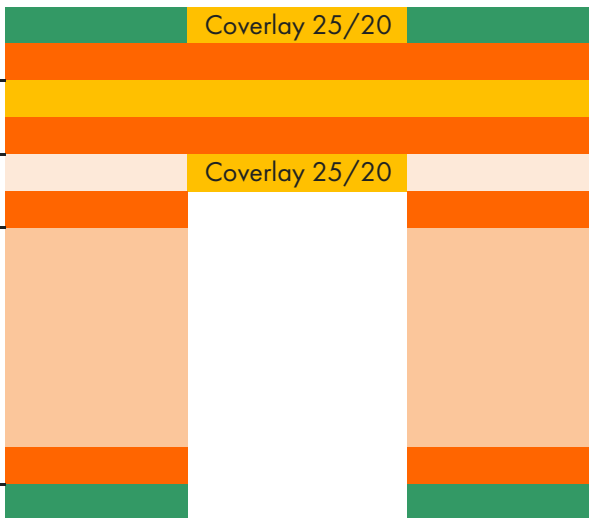
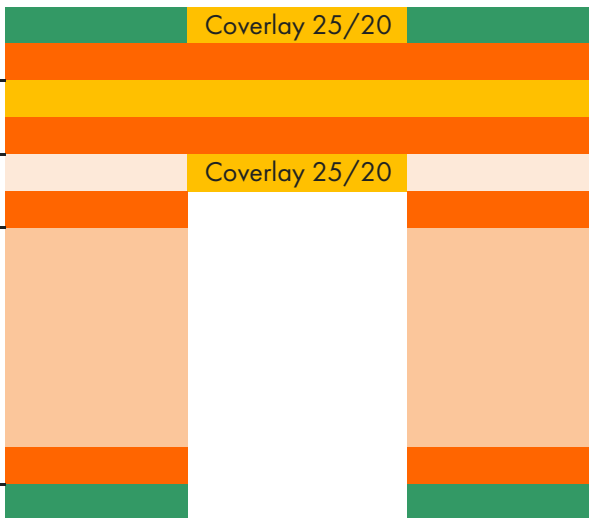
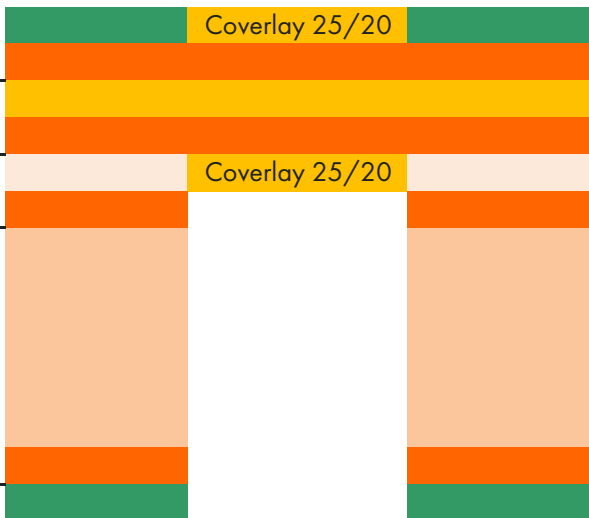
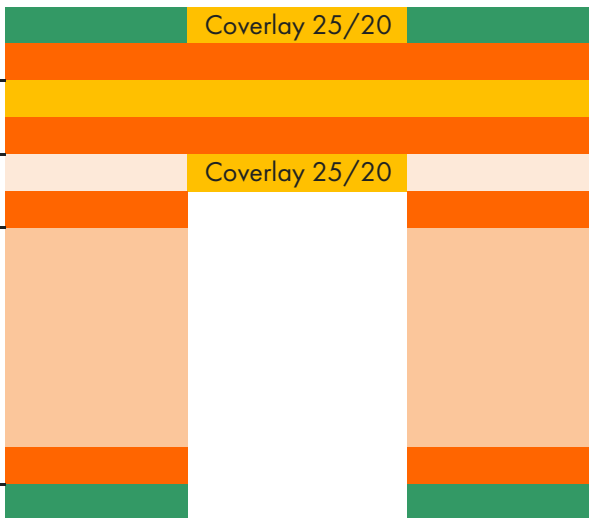
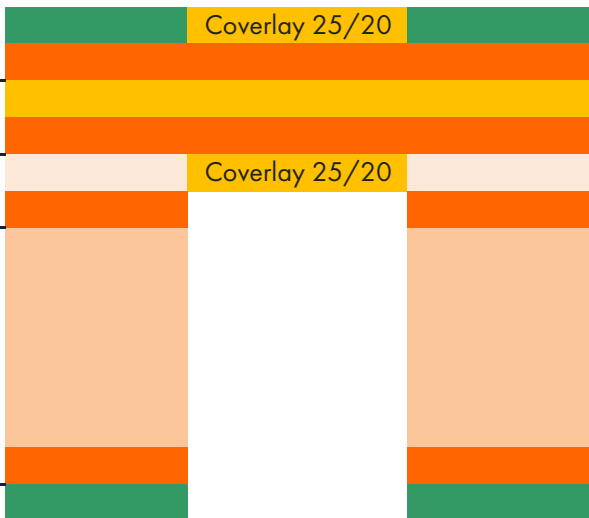
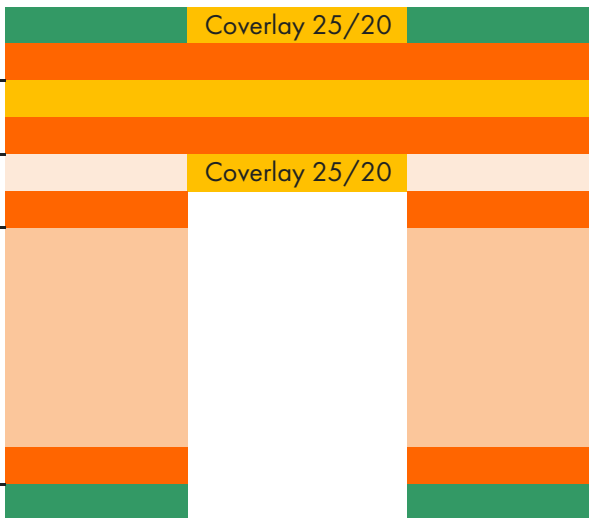
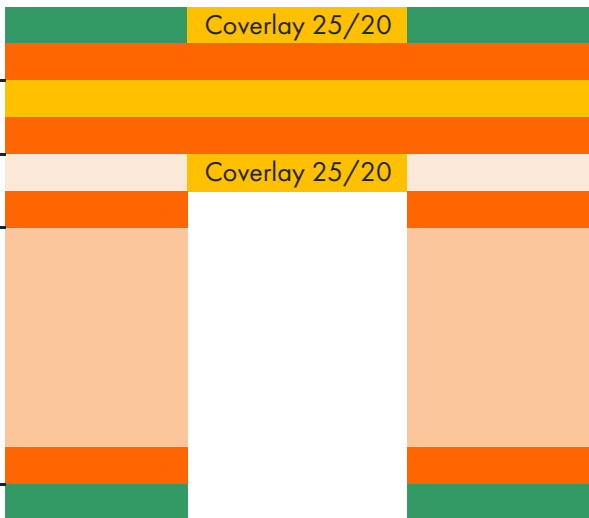
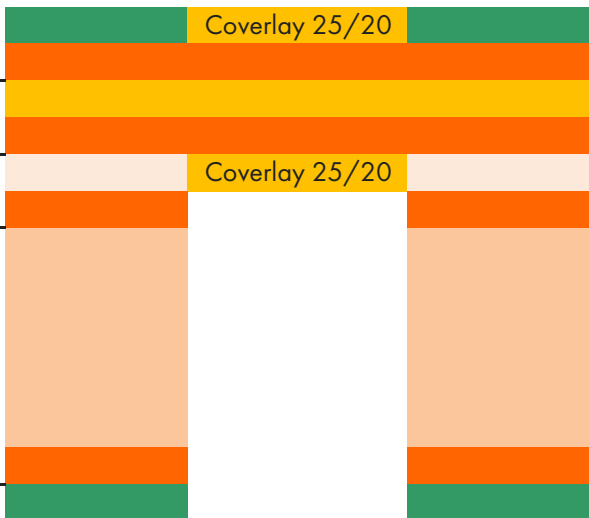


4-Layer Rigid-Flex A1



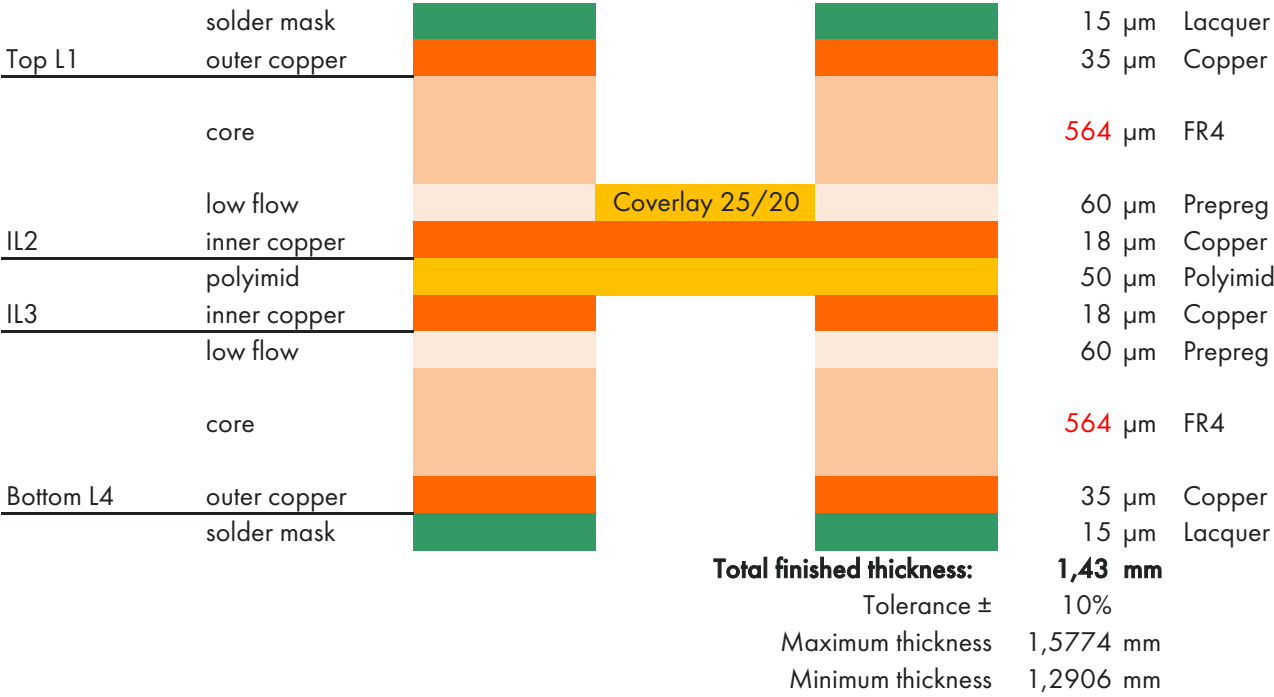
FR4 core thickness 1,0 mm	964 µm	FR4
FR4 core thickness 1,5 mm	1464 µm	FR4
FR4 core thickness 2,0 mm	1964 µm	FR4

4-Layer Rigid-Flex A2

Top L1	solder mask		Coverlay 25/20		15 µm	Lacquer			
	outer copper				35 µm	Copper			
IL2	polyimid		Coverlay 25/20		50 µm	Polyimid			
	inner copper				18 µm	Copper			
IL3	low flow				60 µm	Prepreg			
	inner copper				18 µm	Copper			
	core		Coverlay 25/20		1464 µm	FR4			
	outer copper				35 µm	Copper			
Bottom L4	solder mask		Coverlay 25/20		15 µm	Lacquer			
Total finished thickness:					1,71 mm				
Tolerance ±					10%				
Maximum thickness					1,881 mm				
Minimum thickness					1,539 mm				

FR4 core thickness 1,0 mm	964 µm	FR4
FR4 core thickness 1,5 mm	1464 µm	FR4
FR4 core thickness 2,0 mm	1964 µm	FR4

4-Layer Rigid-Flex I1



FR4 core thickness 1,0 mm	364 µm	FR4
FR4 core thickness 1,5 mm	564 µm	FR4
FR4 core thickness 2,0 mm	964 µm	FR4

4-Layer Rigid-Flex I2

Top L1	solder mask			15 µm	Lacquer
	outer copper			35 µm	
core				564 µm	FR4
IL2	low flow	Coverlay 25/20		60 µm	Prepreg
	inner copper			18 µm	Copper
IL3	polyimid			50 µm	Polyimid
	inner copper			18 µm	Copper
	low flow	Coverlay 25/20		60 µm	Prepreg
	core			564 µm	FR4
Bottom L4	outer copper			35 µm	Copper
	solder mask			15 µm	Lacquer
Total finished thickness:				1,43 mm	
Tolerance ±				10%	
Maximum thickness				1,5774 mm	
Minimum thickness				1,2906 mm	

FR4 core thickness 1,0 mm	364 µm	FR4
FR4 core thickness 1,5 mm	564 µm	FR4
FR4 core thickness 2,0 mm	964 µm	FR4